

SPECIFICATION



YM280T-003HT-240320D4P37

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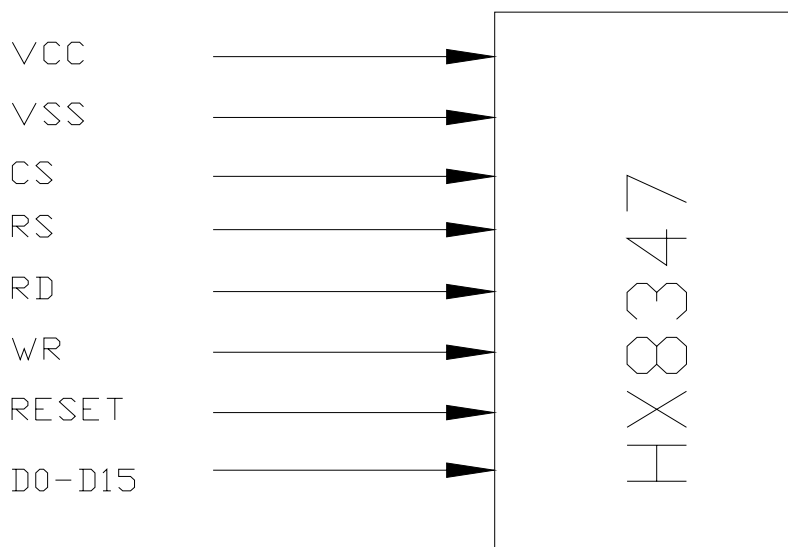
1. FEATURES

ITEM	STANDARD VALUE	UNIT
LCD Type	2.8" QVGA TFT-LCD (Thin Film Transistor Liquid Crystal Display)	---
Viewing Direction	6:00	O'clock
Backlight Type	4-parallel-White LED	---
Module Outsize	50.0 * 69.2 * 4.2 (with TP)	mm
TP Viewing area	44.8 * 63.1	mm
TP Active area	44.2 * 62.5	mm
LCD Active area	43.2 * 57.6	mm
Dot Number	240(RGB) × 320	---
Dot size	0.18*0.18	mm
Operation temperature	-10 ~60	℃
Storage temperature	-30 ~80	℃
Driver IC	HX8347	---
Interface mode	8080 System 16 bit Interface	---

Remark:

1. Display color support 262K/65K, In detail please see also the HX8347 cification.

2. BLOCK DIAGRAM



3. OUTLINE DIMENSIONS

NOTES:

- 1.DISPLAY TYPE:
Main LCD: 2.83" TFT, Transmissive
2. OPERATING TEMP: -20°C~70°C
3. STORAGE TEMP: -30°C~80°C
4. MAIN LCD DRIVER: HX8347
5. BACKLIGHT: 4CHIP-WHITE LED

6. Please ensure there is a distance of 0.4mm from TP.V.A. outward on the place of contact TP side and customer cover side.
(客户面壳压贴TP位应保证与TP.V.A.有向外0.4MM的距离)

REV	EC NUMBER	DESCRIPTION	DATE
①	XXXXXX	XXXXXXXX	xxxx/xx/xx

1	DB0
2	DB1
3	DB2
4	DB3
5	GND1
6	VCC1
7	/CS
8	RS
9	/WR
10	/RD
11	IM0
12	X+
13	Y+
14	X-
15	Y-
16	LEDA
17	LEDK1
18	LEDK2
19	LEDK3
20	LEDK4
21	IM3
22	DB4
23	DB8
24	DB9
25	DB10
26	DB11
27	DB12
28	DB13
29	DB14
30	DB15
31	/RESET
32	VCI
33	VCC2
34	GND
35	DB5
36	DB6
37	DB7

4. NTERFACE PIN CONNECTIONS

PIN	SYMBOL	FUNCTION
1	DB0	Data bus
2	DB1	
3	DB2	
4	DB3	
5	GND	Ground
6	VCC	Power supply
7	/CS	Chip select input pin ("Low" enable).
8	RS	Display data / Command selection pin
9	/WR	Write pin
10	/RD	Read pin
11	NC	NO Connect
12	X+	TP right electrode
13	Y+	TP bottom electrode
14	X-	TP left electrode
15	Y-	TP top electrode
16	LED-A	Backlight power supply
17	LED-K1	Backlight ground
18	LED-K2	
19	LED-K3	
20	LED-K4	
21	NC	NO Connect
22	DB4	Data bus
23	DB8	
24	DB9	
25	DB10	
26	DB11	
27	DB12	
28	DB13	
29	DB14	
30	DB15	
31	/RESET	Reset pin
32	VCI	Power supply
33	VCC	
34	GND	Ground
35	DB5	Data bus
36	DB6	
37	DB7	

5. ELECTRICAL CHARACTERISTICS

5.1 ABSOLUTE MAXIMUM RATING

Please Refer to the SPEC of HX8347.

5.2 DC Characteristics

Please Refer to the SPEC of HX8347.

5.3 AC Characteristics

Please Refer to the SPEC of HX8347.

6. Electro-Optical Characteristics

6.1 Backlight Unit

Item	Symbol	Min	Typ.	Max	Unit	Remark
Input voltage	V _{BL}	3.0	3.2	3.4	V	-
Current	I _{BL}	---	18	---	mA/chip	-
ICE	X	0.26	-	0.30	-	X>Y
	Y	0.27	-	0.31	-	
Brightness	-		T.B.D	---	cd/m ²	
Luminous Intensity Ratio	-	---	----	20	%	-

6.2 LCD panel

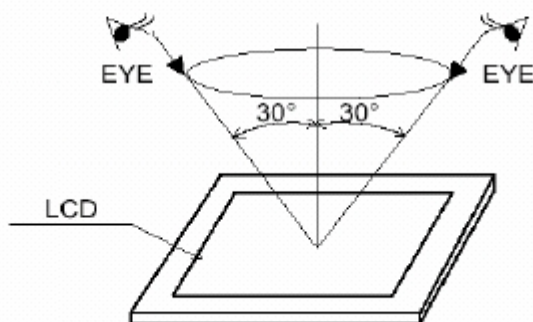
T.B.D

7. QUALITY GUARANTEE & INSPECTION CRITERIA

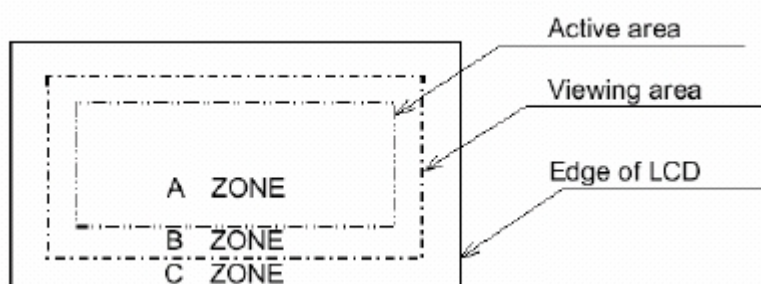
7.1 Appearance inspection

Appearance inspection should be done under the following condition.

- (1) In the dark room.
- (2) The distance from eyes to LCD must be 30 cm.
- (3) Viewing direction must be within 30 degrees to vertical line of LCD center.



7.2 Definition of A zone, B zone and C zone



7.3 Electrical Testing

1. Missing vertical, horizontal segment, segment contrast defect.
2. Missing character, dot or icon.
3. Display malfunction.
4. No function or no display.
5. Current consumption exceeds product specifications.
6. LCD viewing angle defect.
7. Mixed product types.
8. Contrast defect

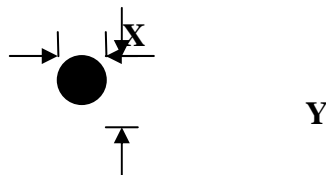
7.4 Black or white spots on LCD (display only)

1. White and black spots on display $\leq 0.20\text{mm}$, no more than three white or black spots present.
2. Densely spaced: No more than two spots or lines within 5mm

7.5 LCD black spots, white spots, contamination (non-display)

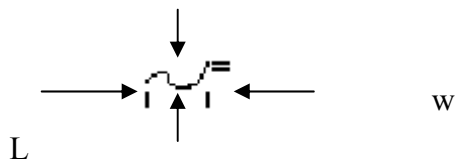
1. Round type: As following drawing

$$\psi = (x+y)/2$$



SIZE	Acceptable QTY
$\psi \leq 0.10$	Accept no dense
0.10 $< \psi \leq 0.15$	2
0.15 $< \psi \leq 0.20$	1
total	2

2. Line Type: (As following drawing)



Length	Width	Acceptable QTY
---	$W \leq 0.02$	Accept no dense
$L \leq 3.0$	$0.02 < W \leq 0.03$	2
$L \leq 2.5$	$0.03 < W \leq 0.05$	
---	$0.05 < W$	As round type

7.6 Polarizer bubbles

If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.

Size ψ	Acceptable QTY
$\psi \leq 0.20$	Accept no dense
$0.20 < \psi \leq 0.50$	2



7.7 Chipped glass

Symbols:

a: Chip length b: Chip width c: Chip thickness

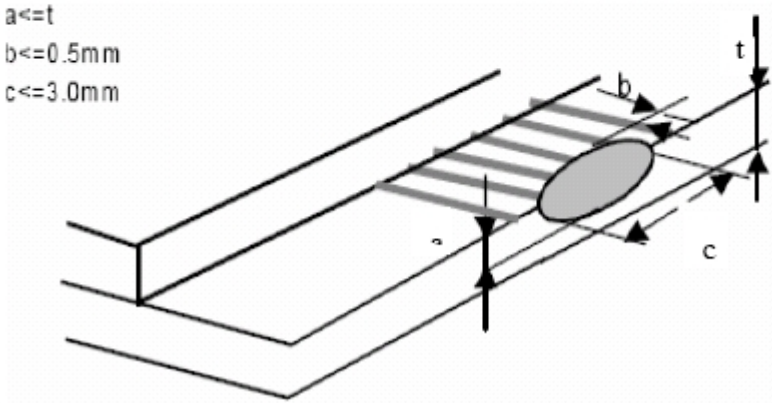
t: Glass thickness

1 ITO electrode

$$a \leq t$$

$$b \leq 0.5\text{mm}$$

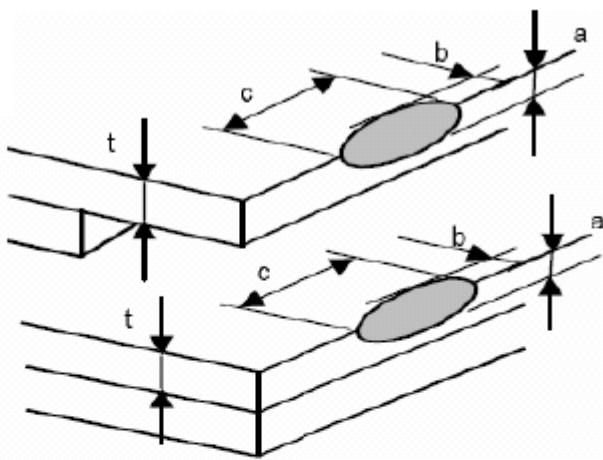
$$c \leq 3.0\text{mm}$$



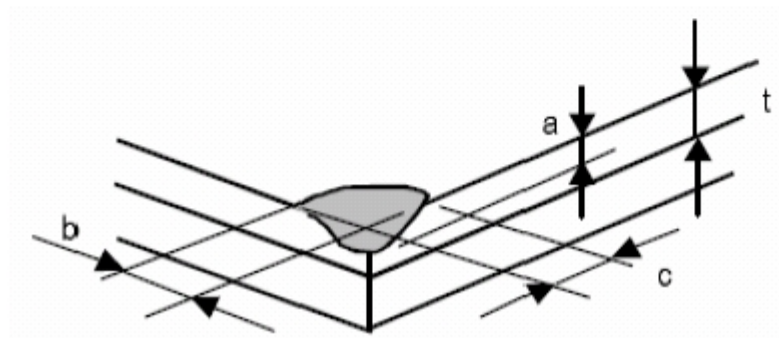
2 General ,corner portion

$$a \leq t$$

$$b \leq 1.0\text{mm}$$



*Effective width of seal area shall be more than 0.3mm.





7.8 Backlight elements

1. Illumination source flickers when lit.
2. Spots or scratches that appear when lit must be judged using LCD spot, lines and contamination standards.
3. Backlight doesn't light or color is wrong

7.9 Soldering

1. No unmelted solder paste may be present on the PCB.
2. No cold solder joints, missing solder connections, oxidation or icicle.
3. No residue or solder balls on PCB.
4. No short circuits in components on PCB.

7.10 General appearance

1. No oxidation, contamination, curves or, bends on interface pin (OLB) of TCP.
2. No cracks on interface pin (OLB) of TCP
3. NO contamination, solder residue or solder balls on product.
4. The IC on the TCP may not be damaged, circuits.
5. The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever.
6. The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.
7. Sealant on top of the ITO circuit has not hardened
8. Pin type must match type in specification sheet.
9. LCD pin loose or missing pins.
10. Product packaging must the same as specified on packaging specification sheet.
11. Product dimension and structure must conform to product specification sheet.
12. The appearance of Heat Seal should not admit any dirt and break.

8. RELIABILITY

Test Item	Sample Type	Test Condition	Test result determinant gist
High temperature storage	Normal temperature	$70 \pm 3^{\circ}\text{C}; 240\text{H}$	the inspection of Appearance and function character.
	Broad temperature	$80 \pm 3^{\circ}\text{C}; 240\text{H}$	
Low temperature storage	Normal temperature	$-20 \pm 3^{\circ}\text{C}; 240\text{H}$	
	Broad temperature	$-30 \pm 3^{\circ}\text{C}; 240\text{H}$	
High temperature	Normal temperature	$50^{\circ}\text{C} \pm 3^{\circ}\text{C}, 90\% \pm 3\%\text{RH}; 240\text{H}$	



/humidity storage	Broad temperature	$60^{\circ}\text{C} \pm 3^{\circ}\text{C}, 90\% \pm 3\%\text{RH}; 240\text{H}$	
High temperature operation	Normal temperature	$60 \pm 3^{\circ}\text{C}; 96\text{H}$	No objection of the function character; no fatal objection of the appearance.
	Broad temperature	$70 \pm 3^{\circ}\text{C}; 96\text{H}$	
Low temperature operation	Normal temperature	$0 \pm 3^{\circ}\text{C}; 96\text{H}$	
	Broad temperature	$-20 \pm 3^{\circ}\text{C}; 96\text{H}$	
High temperature /humidity operation	Normal temperature	$40^{\circ}\text{C} \pm 3^{\circ}\text{C}, 90\% \pm 3\%\text{RH}; 96\text{H}$	
	Broad temperature	$50^{\circ}\text{C} \pm 3^{\circ}\text{C}, 90\% \pm 3\%\text{RH}; 96\text{H}$	
Temperature Shock	Normal temperature	$-20 \pm 3^{\circ}\text{C}, 30\text{min} \rightarrow 70 \pm 3^{\circ}\text{C}, 30\text{min}; 10\text{cycle}$	inspect the objections appearance、function & the whole structure
	Broad temperature	$-30 \pm 3^{\circ}\text{C}, 30\text{min}$ $80 \pm 3, 30\text{min}; 10\text{cycle}$	The inspection of appearance、function & the whole structure
ESD test	ALL	Discharge modality: Air discharge. Discharge voltage: $\pm 2\text{KV} / \pm 4 \text{KV} / \pm 6\text{K} \pm 8\text{KV} / \pm 12\text{KV} / 15\text{KV}$.no software error & objection in $\pm 2\text{KV} \sim \pm 12\text{KV}$, no hardware errors & objection in $\pm 15\text{KV}$.
		Discharge modality: Contact discharge Discharge voltage: $\pm 2\text{KV} / \pm 4 \text{KV} / \pm 6\text{KV} / \pm 8\text{KV}$	no software errors & objection in $\pm 2\text{KV} \sim \pm 12\text{KV}$, no hardware errors & objection in $\pm 8\text{KV}$.
Bend test	ALL	Bend velocity: 60time/min; Bendtimes:50000tims	Stimulate the folder's repeat folding, no objection of display function
Vibration test	ALL	frequencyrange:10HZ~55HZ;swing:0.75mm;Z-axis direction: 60min.	the inspection of appearance、function & the whole structure

9. PRECAUTIONS FOR USING LCD MODULES

Handling Precautions

(1) The display panel is made of glass. Do not subject it to a mechanical shock by dropping it or impact.

(2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.

(3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.

(4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.

(5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents :

- Isopropyl alcohol
- Ethyl alcohol

(6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.

- Water
- Ketone
- Aromatic solvents

(7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.

(8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.

(9) Do not attempt to disassemble or process the LCD module.

(10) NC terminal should be open. Do not connect anything.

(11) If the logic circuit power is off, do not apply the input signals.

(12) To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

- Be sure to ground the body when handling the LCD modules.
- Tools required for assembling, such as soldering irons, must be properly grounded.
- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions.

- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

Storage Precautions



When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags (avoid high temperature, high humidity and low temperatures below 0°C). Whenever possible, the LCD modules should be stored in the same conditions in which they were shipped from our company.

Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.

If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

- Exposed area of the printed circuit board.
- Terminal electrode sections.